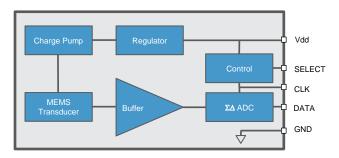
# MULTIMODE DIGITAL TOP PORT SISONIC™ MICROPHONE



The SPG08P4HM4H-1 is a miniature, high-performance, low power, Top port silicon digital microphone with a single bit PDM output. Using Knowles' proven high performance SiSonic™ MEMS technology, the SPG08P4HM4H-1 consists of an acoustic sensor, a low noise input buffer, and a sigma-delta modulator. These devices are suitable for applications such as cellphones, smart phones, laptop computers, sensors, digital still cameras, portable music recorders, and other portable electronic devices where excellent wideband audio performance and RF immunity are required. In addition, the SPG08P4HM4H-1 offers multiple performance modes

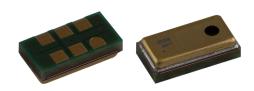


### ABSOLUTE MAXIMUM RATINGS

Table 1: Absolute Maximum Ratings

| Parameter                     | Absolute Maximum Rating     | Units |
|-------------------------------|-----------------------------|-------|
| Vdd to Ground                 | -0.3, +5.0                  | V     |
| DATA, CLOCK, SELECT to Ground | -0.3, +5.0                  | V     |
| Input Current                 | ±5                          | mA    |
| Short Circuit to/from DATA    | Indefinite to Ground or Vdd | sec   |
| Storage Temperature           | -40 to +100                 | °C    |
| Operating Temperature         | -40 to +100                 | °C    |

Stresses exceeding these "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications" is not implied. Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.

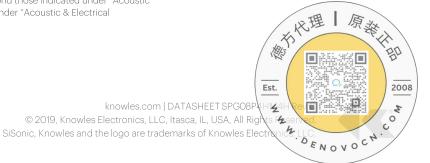


#### PRODUCT FEATURES

- High SNR
- Low Distortion of 1% at 117dB SPL
- Flat Frequency Response
- High Drive Capability
- RF Shielded
- Top Port
- Sensitivity Matching
- Supports Dual Multiplexed Channels
- Multiple Performance Modes (Sleep, Low-Power, Normal)
- Ultra-Stable Performance
- Standard SMD Reflow
- Omnidirectional
- Small Size
- LGA Package

#### TYPICAL APPLICATIONS

- Portable electronics
- Cellphones
- Laptop Computers
- Tablets
- Digital Still Cameras
- Portable Music Recorders





# ACOUSTIC & ELECTRICAL SPECIFICATIONS<sup>1</sup>

#### Table 2: General Microphone Specifications

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Tedge ≤ 3ns, unless otherwise indicated

| Parameter                           | Symbol | Conditions  | Min        | Тур          | Max   | Units |
|-------------------------------------|--------|---|------------|--------------|-------|-------|
| Supply Voltage                      | Vdd    |   | 1.65       | 1.8          | 3.6   | V     |
| Low Frequency Rolloff               | LFRO   | -3dB relative to 1 kHz  |            | 30           |       | Hz    |
| High Frequency Flatness             |        | +3dB relative to 1 kHz  | -          | 10           | -     | kHz   |
| Resonant Frequency Peak             | Fres   | Free Field response   | -          | 20           | -     | kHz   |
| DC Offset                           |        | Fullscale = ±100  | -3.25      | -            | 0.1   | % FS  |
| Directivity                         |        |   | Omnidirect | ional        |       |       |
| Polarity                            |        | Increasing sound pressure   | decreasing | density of 1 | S     |       |
| Data Format                         |        |   | ½ Cycle PI | DM           |       |       |
| Sensitivity Drop                    |        | Vdd(min) ≤ Vdd ≤ Vdd(max)   | -          | -            | ±0.25 | dB    |
| Clock Input Capacitance             | Cin    |   | -          | 5            | -     | pF    |
| Data Output Load                    | Cload  |   | -          | -            | 160   | pF    |
| SELECT (high)                       |        |   | Vdd-0.2    | -            | 3.6   | V     |
| SELECT (low)                        |        |   | -0.3       | -            | 0.2   | V     |
| Short Circuit Current               | Isc    | Grounded DATA pin   | 1          | -            | 20    | mA    |
| Fall-asleep Time <sup>3,4</sup>     |        | Fclock < 250kHz   | -          | -            | 10    | ms    |
| Wake-up Time <sup>3,5</sup>         |        | Fclock ≥ 500kHz   | -          | -            | 20    | ms    |
| Startup Time <sup>3</sup>           |        | Powered Down → Active, S within dB of final value   | -          | -            | 50    | ms    |
| Time to First Data Bit <sup>6</sup> |        | Time from valid Vdd and CLK until the first logical bit is driven on the Data line. The output is tristate until Frist Data bit | -          | 5            |       | ms    |
| Mode-Change Time <sup>3, 6</sup>    |        | Low Power Mode ⇔ Normal Mode  | -          | -            | 10    | ms    |



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Table 3: Normal Mode

Test Conditions: 23  $\pm$ 2°C, 55 $\pm$ 20% R.H., Vdd=1.8 V, Fclock = 2.4 MHz (D.C. = 50%), Tedge  $\leq$  3ns, SELECT grounded, no load, unless otherwise indicated

| Parameter                    | Symbol | Conditions  | Min | Тур  | Max       | Units   |  |
|------------------------------|--------|---|-----|------|-----------|---------|--|
|                              |        | Fclock = 1.2 MHz  | -   | 470  | -         |         |  |
|                              |        | Fclock = 1.536 MHz  | -   | 530  | 670       |         |  |
| Supply Current <sup>2</sup>  | Idd    | Fclock = 2.4 MHz  | -   | 715  | - 670 900 | μΑ      |  |
|                              |        | Fclock = 3.072 MHz  | -   | 1130 | 1400      |         |  |
|                              |        | Fclock = 4.8 MHz  | -   | 1250 | -         |         |  |
| Sensitivity                  | S      | 94 dB SPL @ 1 kHz   | -27 | -26  | -25       | dBFS    |  |
|                              |        | 94 dB SPL @ 1 kHz, A-weighted, Fclock = 1.536MHz                                  | -   | 64   | -         |         |  |
| Signal to Noise Ratio        | SNR    | 94 dB SPL @ 1 kHz, A-weighted, Fclock = 2.4 MHz                                   | -   | 64   | - dB(A)   | dB(A)   |  |
|                              |        | 94 dB SPL @ 1 kHz, A-weighted, Fclock = 3.072 MHz                                 | -   | 64   |           |         |  |
| Tatal Hamania Distantian     | TUD    | 94 dB SPL @ 1 kHz   | -   | 0.1  | -         |         |  |
| Total Harmonic Distortion    | THD    | 115 dB SPL @ 1 kHz  | -   | 0.4  | -         | - %     |  |
|                              |        | 1% THD @ 1 kHz, S = typ   | -   | 117  | -         | dB SPL  |  |
| Acoustic Overload Point      | AOP    | 10% THD @ 1 kHz, S = typ  | -   | 120  | -         | dB SPL  |  |
| Power Supply Rejection Ratio | PSRR   | 200 mVpp sinewave @ 1 kHz   | -   | 83   | -         | dB V/FS |  |
| Power Supply Rejection PSF   |        | 200 mVpp 7/8 duty cycle rectangular waveform<br>@ 217 Hz, A-weighted, BW = 20 kHz | -   | -94  | -         | dBFS(A) |  |

#### Table 4: Low-Power Mode

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 768 kHz (D.C. = 50%), Tedge ≤ 3ns, SELECT grounded, no load, unless otherwise indicated

| Parameter                     | Symbol | Conditions   | Min | Тур | Max  | Units    |
|-------------------------------|--------|--|-----|-----|------|----------|
| Supply Current <sup>2</sup>   | Idd    |  | -   | 290 | 330  | μА       |
| Sensitivity                   | S      | 94 dB SPL @ 1 kHz  | -27 | -26 | -25  | dBFS     |
| Signal to Noise Ratio         | SNR    | 94 dB SPL @ 1 kHz, A-weighted (BW = 8 kHz)                                       | -   | 64  | -    | dB(A)    |
| Total III ama ania Diatantian | TUD    | 94 dB SPL @ 1 kHz  | -   | 0.1 | -    | %        |
| Total Harmonic Distortion     | THD    | 115dB SPL @ 1 kHz  | -   | 0.4 | -    | %        |
|                               |        | 1% THD @ 1 kHz, S = typ  | -   | 117 | -    | dB SPL   |
| Acoustic Overload Point       | AOP    | 10% THD @ 1 kHz, S = typ   | -   | 120 | -    | dB SPL   |
| Power Supply Rejection Ratio  | PSRR   | 200 mVpp sinewave @ 1 kHz  | -   | 80  | -    | dBV/FS   |
| Power Supply Rejection        | PSR+N  | 200 mVpp 7/8 duty cycle rectangular waveform<br>@ 217 Hz, A-weighted, BW = 8 kHz | -   | -89 | 一尺理  | I dB/F A |
|                               |        |  |     |     | 大理 地 |          |

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#### Table 5: Sleep Mode

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 250k Hz, SELECT grounded, no load, unless otherwise indicated

| Parameter     | Symbol | Conditions | Min | Тур | Max | Units |
|---------------|--------|------------|-----|-----|-----|-------|
| Sleep Current | Isleep |            | -   | 35  | 50  | μΑ    |

<sup>&</sup>lt;sup>1</sup> Sensitivity and Supply Current are 100% tested.

#### Table 6: Digital Interface

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Tedge ≤ 3ns, unless otherwise indicated

| Parameter                                   | Symbol | Conditions   | Min      | Тур | Max      | Units |
|---|--------|--|----------|-----|----------|-------|
| Logic Input High <sup>7</sup>               | Vih    |  | 0.7xVdd  | -   | 3.6      | V     |
| Logic Input Low <sup>7</sup>                | Vil    |  | -0.3     | -   | 0.3xVdd  | V     |
| Logic Output High <sup>7</sup>              | Voh    | I <sub>OUT</sub> = 2 mA  | Vdd-0.45 | -   | Vdd      | V     |
| Logic Output Low <sup>7</sup>               | Vol    | I <sub>OUT</sub> = 2 mA  | 0        | -   | 0.45     | V     |
| Low→High Threshold <sup>8</sup>             | VI-h   |  | -        | -   | 0.7xVdd  | V     |
| High→Low Threshold <sup>8</sup>             | Vh-l   |  | 0.3xVdd  | -   | -        | V     |
| Hysteresis Width <sup>8</sup>               | Vhyst  |  | 0.05xVdd | -   | 0.20xVdd | V     |
|   |        | Sleep Mode   | -        | -   | 250      | kHz   |
| Clock Frequency <sup>7</sup>                | Fclock | Low-Power Mode   | 600      | -   | 950      | KIIZ  |
|   |        | Normal Mode  | 1.2      | -   | 4.8      | MHz   |
| Clock Duty Cycle                            | D.C.   |  | 40       | 50  | 60       | %     |
| Delay Time to Data Line Driven <sup>7</sup> | Tdd    |  | 18       | -   | 40       | ns    |
| Delay Time to Valid Data <sup>7</sup>       | Tdv    | Max Cload  | -        | -   | 100      | ns    |
| Delay Time to High Z <sup>7</sup>           | Tdz    |  | 5        | -   | 16       | ns    |
| Hold Time <sup>7</sup>                      | Thold  | Thold, as observed by the input device, will be dependent on Cload | 5        | -   | -        | ns    |

<sup>&</sup>lt;sup>7</sup> See Figure 1: Timing Diagram.



 $<sup>^2</sup>$  Idd varies with Cload according to:  $\Delta$ Idd = 0.5\*Vdd\* $\Delta$ Cload\*Fclock.

<sup>&</sup>lt;sup>3</sup> Valid microphones states are: Powered Down Mode (mic off), Sleep Mode (low current, DATA = high-Z, fast startup), Low-Power Mode (low clock speed) and Normal Mode

 $<sup>^4</sup>$  Time from Fclock < 250 kHz to Isleep specification is met when transitioning from Active Mode to Sleep Mode.

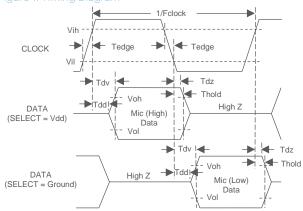
<sup>&</sup>lt;sup>5</sup> Time from Fclock ≥ 600 kHz to all applicable specifications are met when transitioning from Sleep Mode to Active Mode.

<sup>&</sup>lt;sup>6</sup> Audio is temporarily muted during the transition between any microphone state.

<sup>&</sup>lt;sup>8</sup> See Figure 2: Hysteresis Diagram.



Figure 1: Timing Diagram



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Figure 2: Hysteresis Diagram

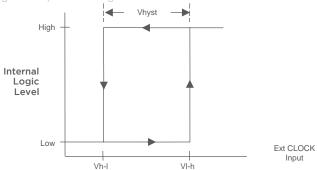


Figure 3: State Diagram

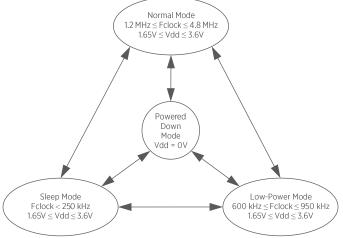
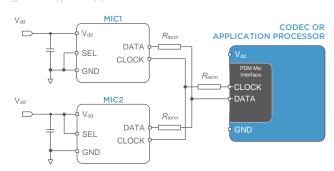


Figure 4: Typical Application Circuit



#### **NOTES**

All Ground pins must be connected to ground.

Bypass capacitors should be placed next to each Vdd pin for best performance. Capacitors near the microphone should not contain Class 2 dielectrics due to their piezoelectric effect.

Table 7: SELECT Functionality

| Microphone | SELECT | Asserts DATA on  | Latch DATA on    |
|------------|--------|------------------|------------------|
| Mic (High) | Vdd    | CLK rising edge  | CLK falling edge |
| Mic (Low)  | Ground | CLK falling edge | CLK rising edge  |





# PERFORMANCE CURVES

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 2.4 MHz, SELECT grounded, no load, unless otherwise indicated

Figure 5: Typical Free Field Magnitude and Phase Response

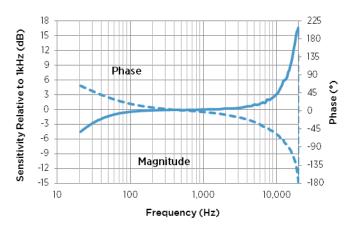


Figure 6: Typical Group Delay

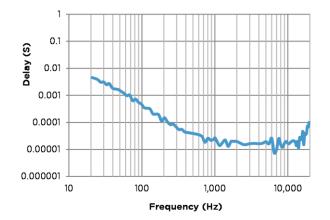


Figure 7: Typical THD vs SPL

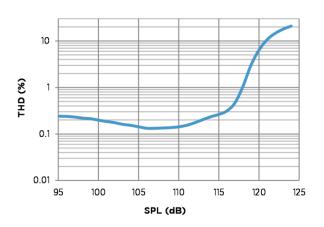


Figure 8: Typical THD vs Frequency

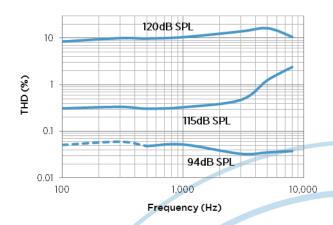






Figure 9: Typical Free Field Ultrasonic Response

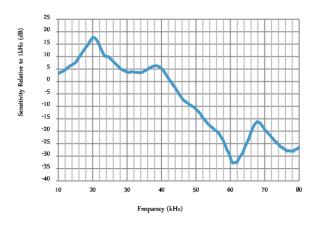


Figure 10: Typical Idd vs Vdd

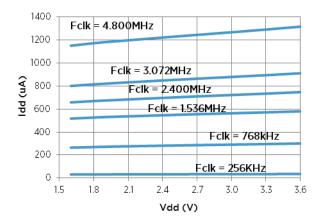


Figure 11: Noise Floor Power Spectral Density

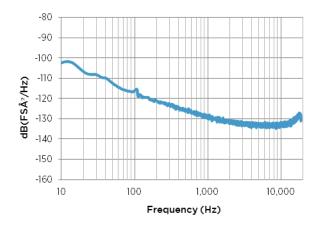
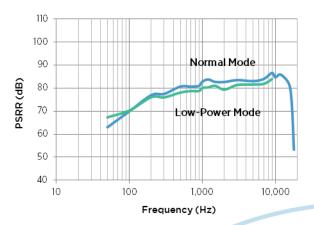
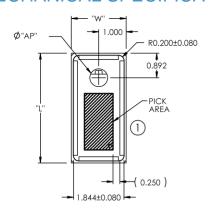


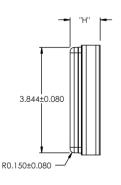
Figure 12: Typical PSRR

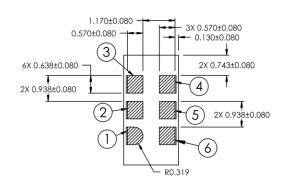




# **MECHANICAL SPECIFICATIONS**



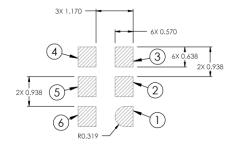




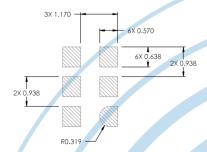
| Item               | Dimension | Tolerance |
|--------------------|-----------|-----------|
| Length (L)         | 4.0       | ±0.10     |
| Width (W)          | 2.0       | ±0.10     |
| Height (H)         | 1.1       | ±0.10     |
| Acoustic Port (AP) | 0.65      | ±0.05     |

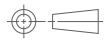
| Pin# | Pin Name | Туре      | Description  |
|------|----------|-----------|--------------|
| 1    | VDD      | Power     | Power Supply |
| 2, 5 | GROUND   | Power     | Ground       |
| 3    | DATA     | Digital O | PDM Output   |
| 4    | CLOCK    | Digital I | Clock Input  |
| 6    | SELECT   | Logicl I  | L/R Select   |

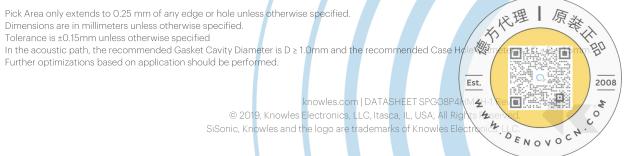
### **Example Land Pattern**



# **Example Solder Stencil Pattern**

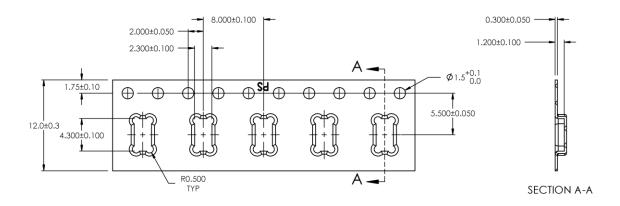






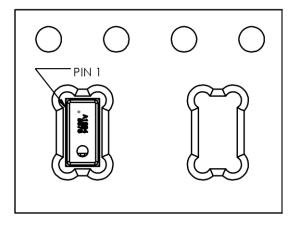


# PACKAGING & MARKING DETAIL



| Model Number  | Suffix | Reel Diameter | Quantity Per<br>Reel |
|---------------|--------|---------------|----------------------|
| SPG08P4HM4H-1 | -8     | 13"           | 5900                 |

| Component    | Surface Resistance (ohms)          |
|--------------|------------------------------------|
| Reel         | 10 <sup>5</sup> - 10 <sup>9</sup>  |
| Carrier Tape | 10 <sup>5</sup> - 10 <sup>9</sup>  |
| Cover Tape   | 10 <sup>4</sup> - 10 <sup>10</sup> |



Letter: "o", orientation mark (pin 1)

Alpha Character A:

- "S": Knowles SiSonicTM Production
- "E": Knowles Engineering Samples
- "P": Knowles Prototype Samples

"12345678":

Unique Job Identification Number for product traceability

#### NOTES:

Dimensions are in millimeters unless otherwise specified.

Vacuum pickup only in the pick area indicated in Mechanical Specifications.

Tape & reel per EIA-481.

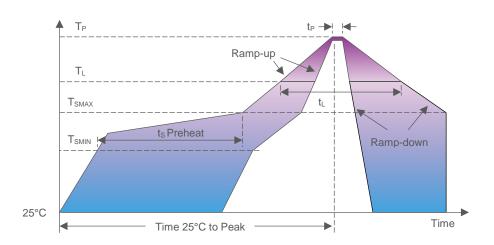
Labels applied directly to reel and external package.

Shelf life: Twelve (12) months when devices are stored in the factory-supplied, unopened ESD moisture sensitive bag under the maximum en 30°C, 70% R.H.





# RECOMMENDED REFLOW PROFILE



| Profile Feature   | Pb-Free                          |
|---|----------------------------------|
| Average Ramp-up rate (T <sub>SMAX</sub> to T <sub>P</sub> )   | 3°C/second max.                  |
| Preheat  Temperature Min (T <sub>SMIN</sub> )  Temperature Max (T <sub>SMAX</sub> )  Time (T <sub>SMIN</sub> to T <sub>SMAX</sub> ) (t <sub>S</sub> ) | 150°C<br>200°C<br>60-180 seconds |
| Time maintained above:  Temperature (T <sub>L</sub> ) Time (t <sub>L</sub> )  | 217°C<br>60-150 seconds          |
| Peak Temperature (T <sub>P</sub> )  | 260°C                            |
| Time within 5°C of actual Peak Temperature (t <sub>P</sub> )  | 20-40 seconds                    |
| Ramp-down rate (T <sub>P</sub> to T <sub>SMAX</sub> )   | 6°C/second max                   |
| Time 25°C to Peak Temperature   | 8 minutes max                    |

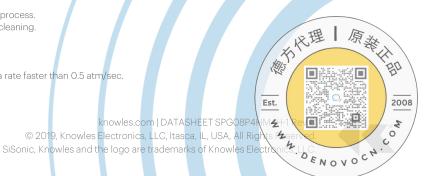
Based on IPC/JDEC J-STD-020 Revision C.

All temperatures refer to topside of the package, measured on the package body surface.

The actual reflow profile used should be optimized based on the reflow requirements of all components, board design, solder paste formulation and reflow equipment used. Details of recommended handling and manufacturing processes can be found in AN25 SMT Manufacturing Guidelines for SiSonic™ Microphones.

- (A) MSL (moisture sensitivity level) Class 1.
- (B) Maximum of 3 reflow cycles is recommended.
- In order to minimize device damage:
  - Do not board wash or clean after the reflow process.
  - Do not brush board with or without solvents after the reflow process.
  - Do not directly expose to ultrasonic processing, welding, or cleaning.
  - Do not insert any object in port hole of device at any time. Do not apply over 30 psi of air pressure into the port hole.

  - Do not pull a vacuum over port hole of the microphone.
  - Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.





# **MATERIALS STATEMENT**

Meets the requirements of the European RoHS directive 2011/65/EC as amended.

Meets the requirements of the industry standard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.

Product is Beryllium Free according to limits specified on the Knowles Hazardous Material List (HSL for Products).

Ozone depleting substances are not used in the product or the processes used to make the product, including compounds listed in Annex A, B, and C of the "Montreal Protocol on Substances That Deplete the Ozone Layer.

### RELIABILITY SPECIFICATIONS

| Test                      | Description  |  |
|---------------------------|--|--|
| Thermal Shock             | 100 cycles of air-air thermal shock from -40°C to +125°C with 15 minute soaks (IEC 68-2-4)                     |  |
| High Temperature Storage  | +105°C environment for 1,000 hours (IEC 68-2-2 Test Ba)  |  |
| Low Temperature Storage   | -40°C environment for 1,000 hours (IEC 68-2-1 Test Aa)   |  |
| High Temperature Bias     | +105°C environment while under bias for 1,000 hours (IEC 68-2-2 Test Ba)                                       |  |
| Low Temperature Bias      | -40°C environment while under bias for 1,000 hours (IEC 68-2-1 Test Aa)  |  |
| Temperature/Humidity Bias | +85°C/85% R.H. environment while under bias for 1,000 hours (JESD22-A101A-B)                                   |  |
| Vibration                 | 12 minutes in each X, Y, Z axis from 20 to 2,000 Hz with peak acceleration of 20 G (MIL 883E, Method 2007.2,A) |  |
| ESD-HBM                   | 3 discharges at ±2kV direct contact to I/O pins (ESD STM5.2)   |  |
| ESD-LID/GND               | 3 discharges at ±8kV direct contact to lid when unit is grounded (IEC 61000-4-2)                               |  |
| ESD-MM                    | 3 discharges at ±200V direct contact to IO pins (MIL 883E, Method 3015.7)                                      |  |
| Reflow                    | 5 reflow cycles with peak temperature of +260°C  |  |
| Mechanical Shock          | 3 pulses of 10,000 G in each of the X, Y, and Z directions (IEC 68-2-27 Test Ea)                               |  |

#### NOTES

Microphones meet all acoustic and electrical specifications before and after reliability testing, except sensitivity which can deviate up to 3dB.

After 3 reflow cycles, the sensitivity of the microphones shall not deviate more than 1 dB from its initial value.





# **SPECIFICATION REVISIONS**

| Revision | Specification Changes                         | Date     |
|----------|---|----------|
| А        | MP release Version ECR #18-2788               | 12/11/18 |
| В        | Correction part number in page 9 ECR# 19-3052 | 4/24/19  |
| С        | Update DC offset DS in DS ECR# 19-3237        | 8/18/19  |
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